

# **HD74LS373**

# Octal D-type Transparent Latches (with three-state outputs)

REJ03D0482-0200 Rev.2.00 Feb.18.2005

The HD74LS373, 8-bit register features totem-pole three-state outputs designed specifically for driving highly-capacitive or relatively low-impedance loads. The high-impedance third state and increased high-logic-level drive provide this register with the capacity of being connected directly to and driving the bus lines in a bus-organized system without need for interface or pull-up components. They are particularly attractive for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

The eight latches are transparent D-type latches meaning that while the enable (G) is high the Q outputs will follow the data (D) inputs. When the enable is taken low the output will be latched at the level of the data that was setup.

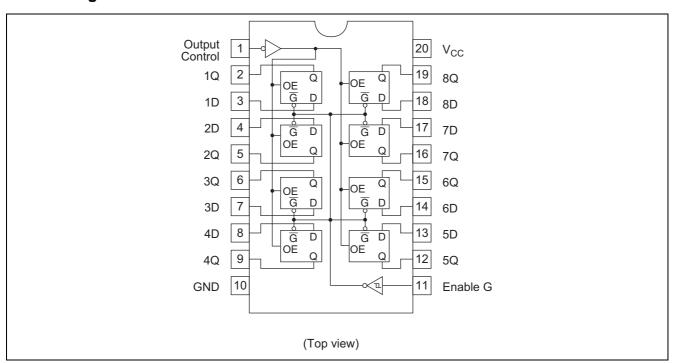
## **Features**

Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LS373P	DILP-20 pin	PRDP0020AC-B (DP-20NEV)	Р	_
HD74LS373FPEL	SOP-20 pin (JEITA)	PRSP0020DD-B (FP-20DAV)	FP	EL (2,000 pcs/reel)
HD74LS373RPEL	SOP-20 pin (JEDEC)	PRSP0020DC-A (FP-20DBV)	RP	EL (1,000 pcs/reel)

Note: Please consult the sales office for the above package availability.

## **Pin Arrangement**



## **Function Table**

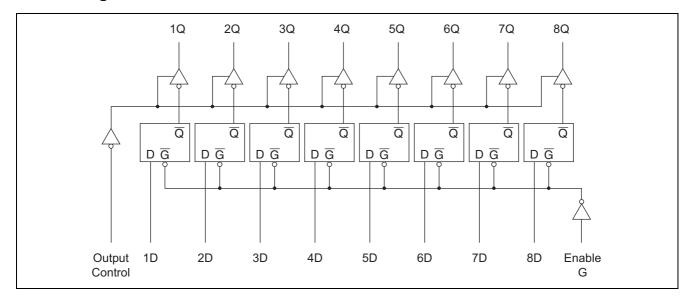
	Output		
Output control	Q		
L	Н	Н	Н
L	Н	L	L
L	L	X	$Q_0$
Н	X	X	Z

Notes: H; high level, L; low level, X; irrelevant

Q<sub>0</sub>; level of Q before the indicated steady-state input conditions were established

Z; off (high-impedance) state of a three-state output

# **Block Diagram**



# **Absolute Maximum Ratings**

Item	Symbol	Ratings	Unit	
Supply voltage	V <sub>CC</sub>	7	V	
Input voltage	$V_{IN}$	7	V	
Power dissipation	P <sub>T</sub>	400	mW	
Storage temperature	Tstg	-65 to +150	°C	

Note: Voltage value, unless otherwise noted, are with respect to network ground terminal.

## **Recommended Operating Conditions**

Item		Symbol	Min	Тур	Max	Unit
Supply voltage		V <sub>CC</sub>	4.75	5.00	5.25	V
Output voltage		$V_{OH}$	_	_	5.5	V
Output current		I <sub>OH</sub>	_	_	-2.6	mA
		I <sub>OL</sub>	_	_	24	mA
Operating temperature		Topr	-20	25	75	°C
Enable pulse width	"H" Level	+	15	_	_	ns
Enable pulse width	"L" Level	$t_w$	15	_	_	ns
Data setup time		t <sub>su</sub>	5↓	_	_	ns
Data hold time		t <sub>h</sub>	20↓	_	_	ns

# **Electrical Characteristics**

 $(Ta = -20 \text{ to } +75 \text{ }^{\circ}\text{C})$ 

Item	Symbol	min.	typ.*	max.	Unit	Condition	
	$V_{IH}$	2.0	_	_	V		
Input voltage		_	_	0.7	V	Data inputs	
	V <sub>IL</sub>	_	_	0.8	V	G, Output control inputs	
Outrat and the ma	V <sub>OH</sub>	2.4	_	_	V	$V_{CC} = 4.75 \text{ V}, V_{IH} = 2 \text{ V}, V_{IL} = V_{IL \text{ max}}$ $I_{OH} = -2.6 \text{ mA}$	
Output voltage	\/	_	_	0.4	V	$I_{OL} = 12 \text{ mA}$ $V_{CC} = 4.75 \text{ V},$	
	V <sub>OL</sub>	_	_	0.5	V	$I_{OL} = 24 \text{ mA}$ $V_{IH} = 2 \text{ V}, V_{IL} = V_{IL \text{ max}}$	
Output ourrant	I <sub>OZH</sub>	_	_	20	^	$V_0 = 2.7 \text{ V}$ $V_{CC} = 5.25 \text{ V}$ ,	
Output current	I <sub>OZL</sub>	_	_	-20	μΑ	V <sub>O</sub> = 0.4 V V <sub>IH</sub> = 2 V	
	I <sub>IH</sub>	_	_	20	μΑ	$V_{CC} = 5.25 \text{ V}, V_I = 2.7 \text{ V}$	
Input current	I <sub>IL</sub>	_	_	-0.4	mA	V <sub>CC</sub> = 5.25 V, V <sub>I</sub> = 0.4 V	
	l <sub>l</sub>	_	_	0.1	mA	V <sub>CC</sub> = 5.25 V, V <sub>I</sub> = 7 V	
Short-circuit output current	los	-30	_	-130	mA	V <sub>CC</sub> = 5.25 V	
Supply current	Icc	_	24	40	mA	$V_{CC} = 5.25 \text{ V},$ $V_{I} = 4.5 \text{ V} \text{ (Output control)}$	
Input clamp voltage	V <sub>IK</sub>	_	_	-1.5	V	$V_{CC} = 4.75 \text{ V}, I_{IN} = -18 \text{ mA}$	

Note:  $^* V_{CC} = 5 \text{ V}, \text{ Ta} = 25^{\circ}\text{C}$ 

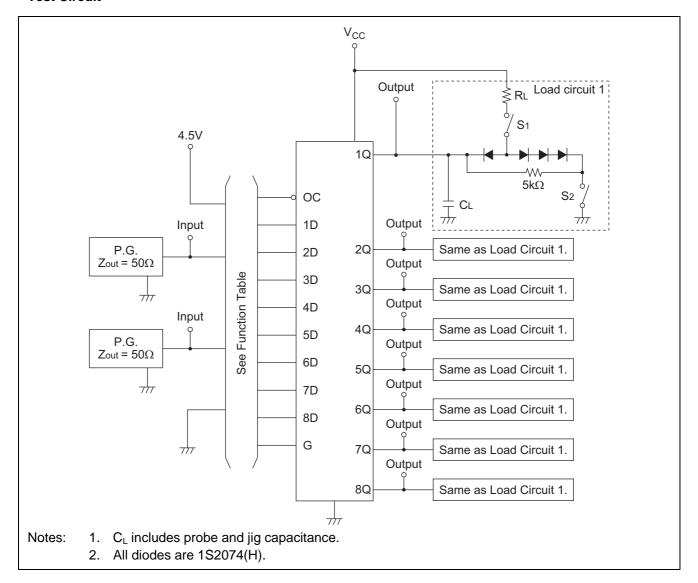
# **Switching Characteristics**

 $(V_{CC} = 5 \text{ V}, \text{ Ta} = 25^{\circ}\text{C})$ 

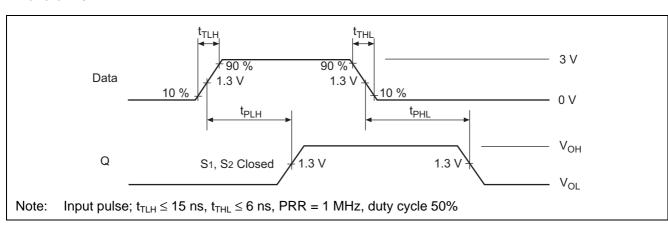
Item	Symbol	Input	Output	min.	typ.	max.	Unit	Condition
Propagation delay time	t <sub>PLH</sub>	D	Q		12	18	ns	$C_L$ = 45 pF, $R_L$ = 667 $\Omega$
	t <sub>PHL</sub>	U		_	12	18		
	t <sub>PLH</sub>	G	Q	_	20	30		
	t <sub>PHL</sub>			_	18	30		
Output enable time	t <sub>ZH</sub>	OC	Q	_	15	28		
	$t_{ZL}$	00		_	25	36		
Output disable time	t <sub>HZ</sub>	ОС	Q	_	12	20		$C_L = 5 pF$ ,
	$t_{LZ}$	00	Q	_	15	25		$R_L = 667 \Omega$

## **Testing Method**

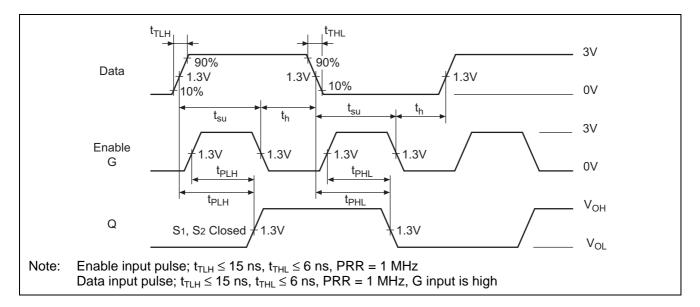
## **Test Circuit**



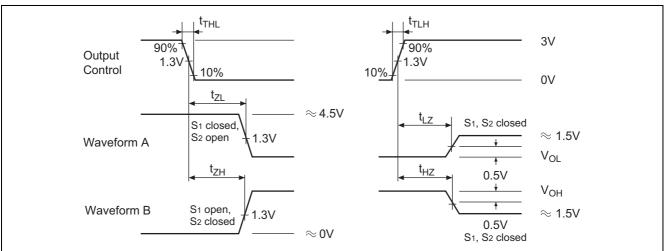
#### Waveforms 1



## Waveforms 2



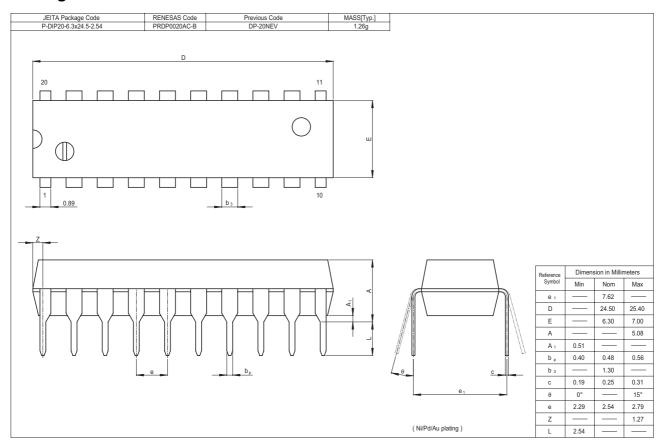
## Waveforms 3

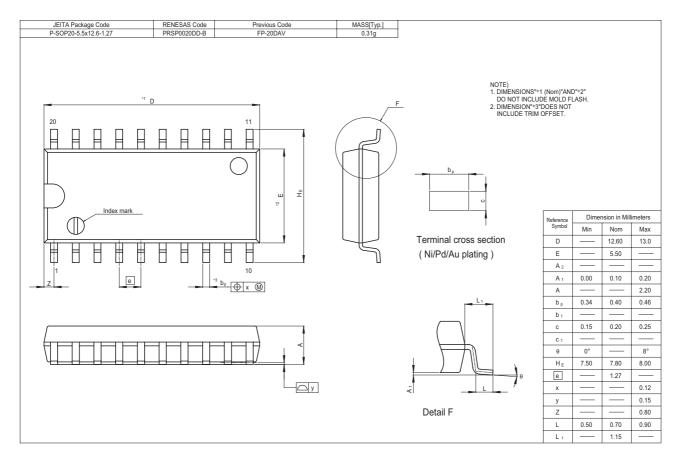


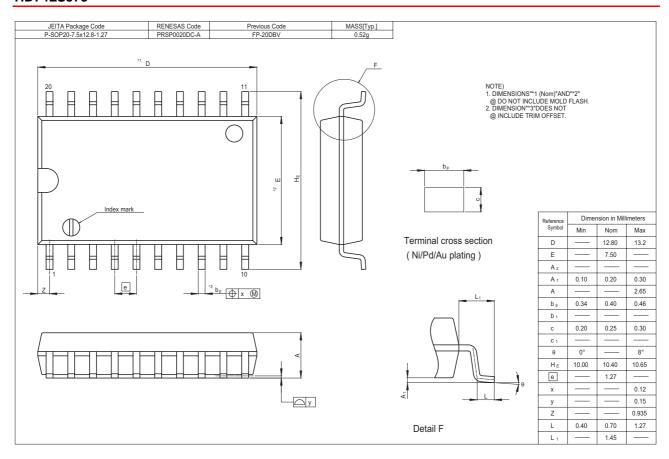
Notes:

- 1. Input pulse;  $t_{TLH} \le 15$  ns,  $t_{THL} \le 6$  ns, PRR = 1 MHz, duty cycle 50%
- 2. Waveform A if for an output with internal conditions such that the output is low except when disabled by the output control. Waveform B is for an output with internal conditions such that the output is high except when disabled by the output control.

## **Package Dimensions**







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